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# 2SA1468

Silicon PNP Epitaxial

# HITACHI

ADE-208-1018 (Z)

1st. Edition

Mar. 2001

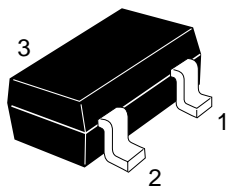
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## Application

High voltage amplifier

## Outline

MPAK



- 1. Emitter
- 2. Base
- 3. Collector

Absolute Maximum Ratings (Ta = 25°C)

Item	Symbol	Ratings	Unit
Collector to base voltage	$V_{CBO}$	-180	V
Collector to emitter voltage	$V_{CEO}$	-180	V
Emitter to base voltage	$V_{EBO}$	-5	V
Collector current	$I_C$	-100	mA
Collector power dissipation	$P_C$	150	mW
Junction temperature	$T_j$	150	°C
Storage temperature	$T_{stg}$	-55 to +150	°C

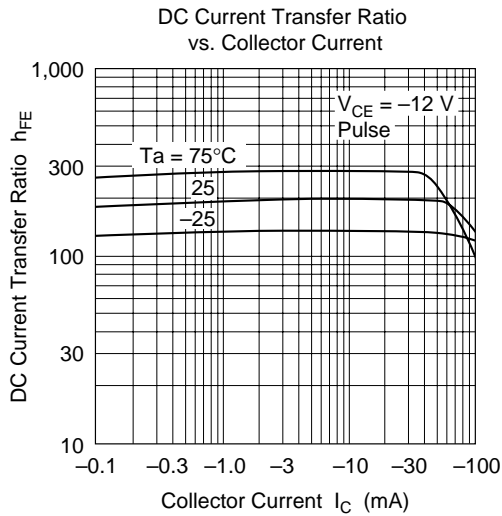
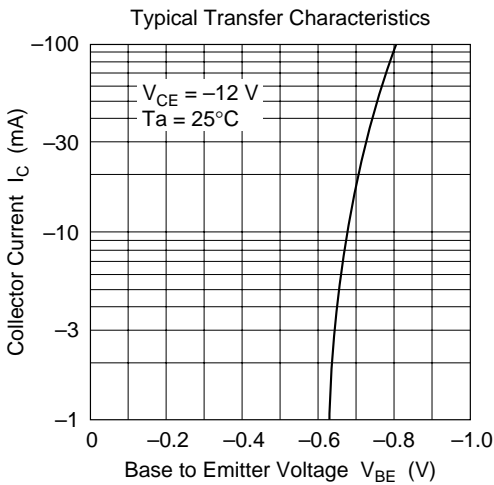
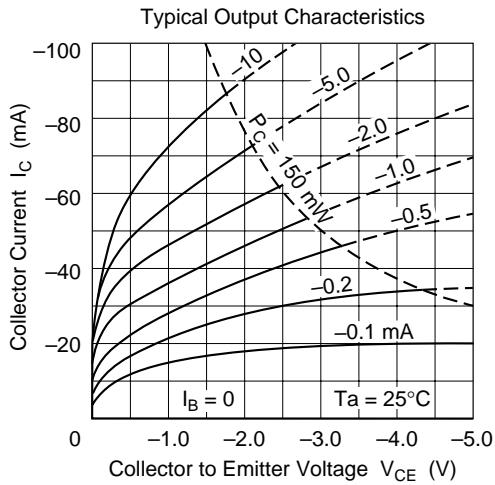
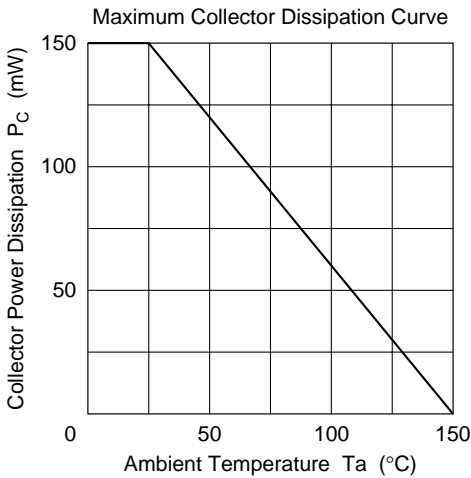
Electrical Characteristics (Ta = 25°C)

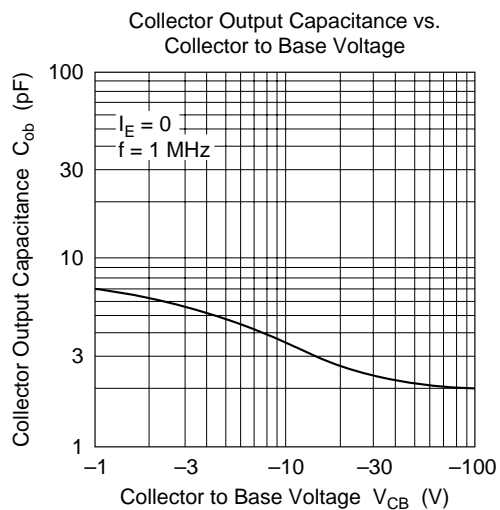
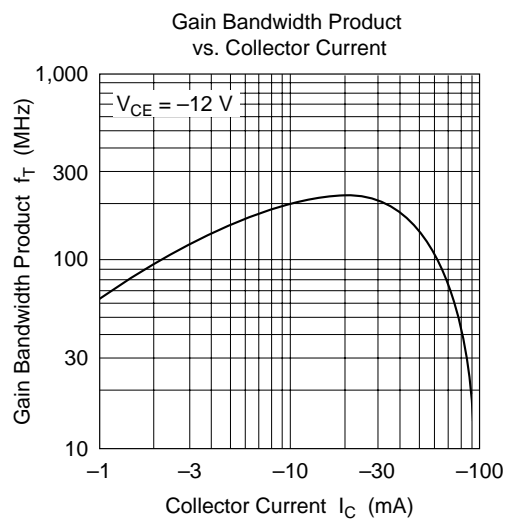
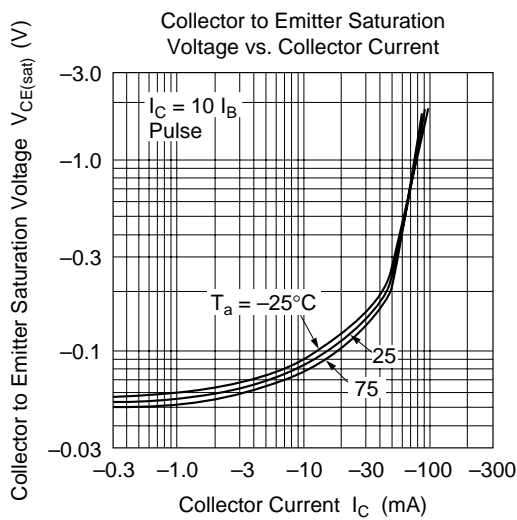
Item	Symbol	Min	Typ	Max	Unit	Test conditions
Collector to base breakdown voltage	$V_{(BR)CBO}$	-180	—	—	V	$I_C = -10\text{ }\mu\text{A}$ , $I_E = 0$
Collector to emitter breakdown voltage	$V_{(BR)CEO}$	-180	—	—	V	$I_C = -0.5\text{ mA}$ , $R_{BE} = \infty$
Emitter to base breakdown voltage	$V_{(BR)EBO}$	-5	—	—	V	$I_E = -10\text{ }\mu\text{A}$ , $I_C = 0$
DC current transfer ratio	$h_{FE}^{*1}$	100	—	320		$V_{CE} = -12\text{ V}$ , $I_C = -2\text{ mA}^{*2}$
Collector to emitter saturation voltage	$V_{CE(sat)}$	—	—	-0.5	V	$I_C = -30\text{ mA}$ , $I_B = -3\text{ mA}^{*2}$
Base to emitter voltage	$V_{BE}$	—	—	-1.0	V	$V_{CE} = -12\text{ V}$ , $I_C = -2\text{ mA}$
Gain bandwidth product	$f_T$	—	200	—	MHz	$V_{CE} = -12\text{ V}$ , $I_C = -10\text{ mA}$
Collector output capacitance	$C_{ob}$	—	3.5	—	pF	$V_{CB} = -10\text{ V}$ , $I_E = 0$ , $f = 1\text{ MHz}$

Notes: 1. The 2SA1468 is grouped by  $h_{FE}$  as follows.

2. Pulse test

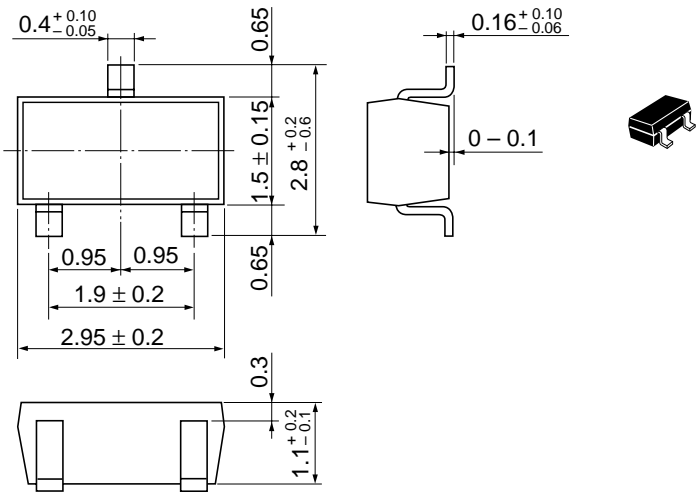
Grade	B	C
Mark	INB	INC
$h_{FE}$	100 to 200	160 to 320





Package Dimensions

As of January, 2001  
Unit: mm



Hitachi Code	MPAK
JEDEC	—
EIAJ	Conforms
Mass (reference value)	0.011 g

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